

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ichiro KODAKA, *et al.*
Serial No.: 10/754,381
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For: *Layered Support And Method For Laminating CMP Pads*
Art Group Unit: 1733
Examiner: John L. GOFF
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Customer No.: 30764
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AMENDMENT "B" UNDER 37 CFR § 1.312

Commissioner for Patents
Office of Patent Publication
Mail Stop Issue Fee
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Allowance dated September 12, 2006, please amend the application as follows.

Amendments to the Drawings begin on page 2 of this paper;

Remarks begin on page 3 of this paper.